

VN1706L, VN1706M

N-Channel Enhancement-Mode MOS Transistors

PRODUCT SUMMARY

PART NUMBER	V _{(BR)DSS} (V)	r _{D(S)ON} (Ω)	I _D (A)	PACKAGE
VN1706L	170	6	0.22	TO-92
VN1706M	170	6	0.25	TO-237

Performance Curves: VNDB24 (See Section 7)

T-27-25

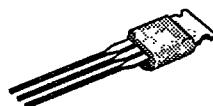
TO-92



BOTTOM VIEW


 1 SOURCE
 2 GATE
 3 DRAIN

TO-237



BOTTOM VIEW


 1 SOURCE
 2 GATE
 3 DRAIN
ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	VN1706L	VN1706M	UNITS
Drain-Source Voltage		V _{DS}	170	170	V
Gate-Source Voltage		V _{GS}	±30	±30	
Continuous Drain Current	T _A = 25°C	I _D	0.22	0.25	A
	T _A = 100°C		0.14	0.16	
Pulsed Drain Current ¹		I _{DM}	2.3	2.5	W
Power Dissipation	T _A = 25°C	P _D	0.8	1.0	
	T _A = 100°C		0.32	0.4	
Operating Junction and Storage Temperature		T _J , T _{stg}	-55 to 150		°C
Lead Temperature (1/16" from case for 10 seconds)		T _L	300		

6

THERMAL RESISTANCE

THERMAL RESISTANCE		SYMBOL	VN1706L	VN1706M	UNITS
Junction-to-Ambient	R _{thJA}		156	125	°C/W

¹Pulse width limited by maximum junction temperature

VN1706L, VN1706M

T-27-25

 **Siliconix**
incorporated

ELECTRICAL CHARACTERISTICS ¹			LIMITS			
PARAMETER	SYMBOL	TEST CONDITIONS	TYP ²	MIN	MAX	UNIT
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$	230	170		V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1.4	0.8	2.0	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}$ $V_{GS} = \pm 15 \text{ V}$ $T_J = 125^\circ\text{C}$	± 1		± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 120 \text{ V}$ $V_{GS} = 0 \text{ V}$ $T_J = 125^\circ\text{C}$	0.01		10	μA
On-State Drain Current ³	$I_{D(\text{ON})}$	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}$	1.2	1		A
Drain-Source On-Resistance ³	$r_{DS(\text{ON})}$	$V_{GS} = 2.5 \text{ V}, I_D = 0.1 \text{ A}$	7.5		10	Ω
		$V_{GS} = 10 \text{ V}$ $I_D = 0.5 \text{ V}$ $T_J = 125^\circ\text{C}$	5		6	
Forward Transconductance ³	g_{FS}	$V_{DS} = 10 \text{ V}, I_D = 0.5 \text{ A}$	530	300		mS
Common Source Output Conductance ³	g_{OS}	$V_{DS} = 7.5 \text{ V}, I_D = 0.5 \text{ A}$	475			μs
DYNAMIC						
Input Capacitance	C_{iss}	$V_{DS} = 25 \text{ V}$ $V_{GS} = 0 \text{ V}$ $f = 1 \text{ MHz}$	105		125	pF
Output Capacitance	C_{oss}		25		50	
Reverse Transfer Capacitance	C_{rss}		5		20	
SWITCHING						
Turn-On Time	$t_{d(\text{ON})}$	$V_{DD} = 60 \text{ V}, R_L = 150 \Omega$ $I_D = 0.1 \text{ A}, V_{GEN} = 10 \text{ V}$ $R_G = 25 \Omega$ (Switching time is essentially independent of operating temperature)	3		8	ns
	t_r		2		8	
Turn-Off Time	$t_{d(\text{OFF})}$		13		18	
	t_f		9		12	

- NOTES: 1. $T_A = 25^\circ\text{C}$ unless otherwise noted.
 2. For design aid only, not subject to production testing.
 3. Pulse test; $PW = 300 \mu\text{s}$, duty cycle $\leq 2\%$.